

# 8Gb (x16 x 2 channel) Mobile LPDDR4/LPDDR4X

**DECEMBER 2021** 

#### **FEATURES**

- Configuration:
  - 256Mb x16 x 2 channels
  - 8 internal banks per each channel
- Low-voltage Core and I/O Power Supplies

VDD1 = 1.70-1.95V

VDD2 = 1.06-1.17V

VDDQ = 1.06-1.17V (LPDDR4)

VDDQ = 0.57-0.65V (LPDDR4X)

- LVSTL(Low Voltage Swing Terminated Logic) I/O Interface
- Internal VREF and VREF Training
- · Dynamic ODT:

DQ ODT: VSSQ Termination

CA ODT: VSS Termination

- Max. Clock Frequency: 1.6GHz (3.2Gbps)
- · 16n Pre-fetch DDR architecture
- Single data rate (multiple cycles) command/ address bus
- Bidirectional/differential data strobe per byte of data (DQS/DQS#)
- Programmable and on-the-fly burst lengths (BL=16, 32)
- ZQ Calibration
- · Operation Temperature

Industrial (Tc = -40°C to 95°C)

Automotive, A1 ( $T_C = -40^{\circ}C$  to 95°C)

Automotive, A2 ( $T_C = -40^{\circ}C$  to  $105^{\circ}C$ )

Automotive, A3 (Tc = -40°C to 125°C)

Clock-Stop capability

#### **DESCRIPTION**

The IS43/46LQ32256A and IS43/46LQ32256AL are 8Gbit CMOS LPDDR4 SDRAM. The device is organized as 2 channels per device, and individual channel is 8-banks and 16-bits. This product uses a double-data-rate architecture to achieve high-speed operation. The double data rate architecture is essentially a 16N prefetch architecture with an interface designed to transfer two data words per clock cycle at the I/O pins. This product offers fully synchronous operations referenced to both rising and falling edges of the clock. The data paths are internally pipelined and 16n bits prefetched to achieve very high bandwidth.

- On-chip temperature sensor whose status can be read from MR4
- 200-ball x32 BGA Package (10x14.5 mm)

#### **ADDRESS TABLE**

Parameter	
# of Channel	2
Row Addresses	R0-R14
Column Addresses	C0-C9
Bank Addresses	BA0-BA2

Note: Address information is per channel base.

### **KEY TIMING PARAMETERS**

Speed	Freq.	Data	Wi Late	rite ency	Rea Late	
Grade	(MHz)	Rate (Mb/s)	Set	Set	DBI	DBI
		(1015/3)	Α	В	OFF	ON
-062	1600	3200	14	26	28	32
-075	1333	2666	12	22	24	28

**Note**: Other clock frequencies/data rates supported; please refer to AC timing tables.

Copyright © 2021 Integrated Silicon Solution, Inc. All rights reserved. ISSI reserves the right to make changes to this specification and its products at any time without notice. ISSI assumes no liability arising out of the application or use of any information, products or services described herein. Customers are advised to obtain the latest version of this device specification before relying on any published information and before placing orders for products.

Integrated Silicon Solution, Inc. does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless Integrated Silicon Solution. Inc. receives written assurance to its satisfaction, that:

a.) the risk of injury or damage has been minimized;

b.) the user assume all such risks; and

c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances



## 1. BALL ASSIGNMENTS AND DESCRIPTIONS

## 200-ball x32 Discrete Package, 0.80mm x 0.65mm using MO-311

	1	2	3	4	5	6 7	8	9	10	11	12
Α	DNU	DNU	vss	VDD2	ZQ0	0.80mm Pitch	NC	VDD2	vss	DNU	DNU
В	DNU	DQ0_A	VDDQ	DQ7_A	VDDQ		VDDQ	DQ15_A	VDDQ	DQ8_A	DNU
С	vss	DQ1_A	DMI0_A	DQ6_A	vss		vss	DQ14_A	DMI1_A	DQ9_A	vss
D	VDDQ	vss	DQS0_T_A	vss	VDDQ		VDDQ	vss	DQS1_T_A	vss	VDDQ
E	vss	DQ2_A	DQS0_C_ A	DQ5_A	vss		vss	DQ13_A	DQS1_C_ A	DQ10_A	vss
F	VDD1	DQ3_A	VDDQ	DQ4_A	VDD2		VDD2	DQ12_A	VDDQ	DQ11_A	VDD1
G	vss	ODT_CA_ A (3)	vss	VDD1	vss		vss	VDD1	vss	NC	vss
н	VDD2	CA0_A	NC	CS0_A	VDD2		VDD2	CA2_A	CA3_A	CA4_A	VDD2
J	vss	CA1_A	vss	CKE0_A	NC		CK_t_A	CK_c_A	vss	CA5_A	vss
yitch ×	VDD2	vss	VDD2	vss	NC		NC	vss	VDD2	vss	VDD2
0.65mm Pitch											
0.65 N	VDD2	vss	VDD2	vss	NC		NC	vss	VDD2	vss	VDD2
Р	vss	CA1_B	vss	CKE0_B	NC		CK_T_B	CK_C_B	vss	CA5_B	vss
R	VDD2	CA0_B	NC	CS0_B	VDD2		VDD2	CA2_B	CA3_B	CA4_B	VDD2
т	vss	ODT_CA_ B (3)	vss	VDD1	vss		vss	VDD1	vss	RESET_N	vss
U	VDD1	DQ3_B	VDDQ	DQ4_B	VDD2		VDD2	DQ12_B	VDDQ	DQ11_B	VDD1
v	vss	DQ2_B	DQS0_C_ B	DQ5_B	vss		vss	DQ13_B	DQS1_C_ B	DQ10_B	vss
w	VDDQ	vss	DQS0_T_B	vss	VDDQ		VDDQ	vss	DQS1_T_B	vss	VDDQ
Y	vss	DQ1_B	DMI0_B	DQ6_B	vss		vss	DQ14_B	DMI1_B	DQ9_B	vss
AA	DNU	DQ0_B	VDDQ	DQ7_B	VDDQ		VDDQ	DQ15_B	VDDQ	DQ8_B	DNU
АВ	DNU	DNU	vss	VDD2	VSS		vss	VDD2	vss	DNU	DNU

NOTE 1 0.8mm pitch (X-axis), 0.65mm pitch (Y-axis), 22 rows.

NOTE 2 Top View, A1 in top left corner.

NOTE 3 The ODT\_CA pin is ignored by LPDDR4X devices.



## 2. INPUT/OUTPUT FUNTIONAL DESCRIPTION

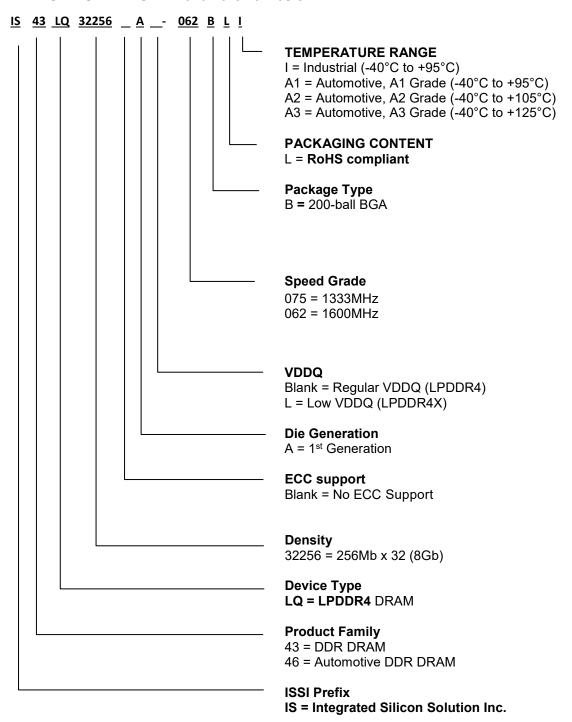
## 2.1 PAD DEFINITION AND DESCRIPTION

Table 2.1 — Pad Definition and Description

Symbol	Type	Description
CK_t_A, CK_c_A, CK_t_B, CK_c_B	Input	Clock: CK_t and CK_c are differential clock inputs. All address, command, and control input signals are sampled on the crossing of the positive edge of CK_t and the negative edge of CK_c. AC timings for CA parameters are referenced to CK. Each channel (A & B) has its own clock pair.
CKE_A CKE_B	Input	Clock Enable: CKE HIGH activates and CKE LOW deactivates the internal clock circuits, input buffers, and output drivers. Power-saving modes are entered and exited via CKE transitions. CKE is part of the command code. Each channel (A & B) has its own CKE signal.
CS_A CS_B	Input	<b>Chip Select:</b> CS is part of the command code. Each channel (A & B) has its own CS signal.
CA[5:0]_A CA[5:0]_B	Input	<b>Command/Address Inputs:</b> CA signals provide the Command and Address inputs according to the Command Truth Table. Each channel (A&B) has its own CA signals.
ODT_CA_A ODT_CA_B	Input	LPDDR4 CA ODT Control: The ODT_CA pin is used in conjunction with the Mode Register to turn on/off the On-Die-Termination for CA pins.  LPDDR4X CA ODT Control: The ODT_CA pin is ignored by LPDDR4X devices. CA ODT is fully controlled through MR11 and MR22. The ODT_CA pin shall be connected to either VDD2 or VSS.
DQ[15:0]_A, DQ[15:0]_B	I/O	Data Input/Output: Bi-direction data bus.
DQS[1:0]_t_A, DQS[1:0]_c_A, DQS[1:0]_t_B, DQS[1:0]_c_B	I/O	<b>Data Strobe:</b> DQS_t and DQS_c are bi-directional differential output clock signals used to strobe data during a READ or WRITE. The Data Strobe is generated by the DRAM for a READ and is edge-aligned with Data. The Data Strobe is generated by the Memory Controller for a WRITE and must arrive prior to Data. Each byte of data has a Data Strobe signal pair. Each channel (A & B) has its own DQS strobes.
DMI[1:0]_A, DMI[1:0]_B	I/O	<b>Data Mask Inversion:</b> DMI is a bi-directional signal which is driven HIGH when the data on the data bus is inverted, or driven LOW when the data is in its normal state. Data Inversion can be disabled via a mode register setting. Each byte of data has a DMI signal. Each channel (A & B) has its own DMI signals.
ZQ	Reference	<b>Calibration Reference:</b> Used to calibrate the output drive strength and the termination resistance. There is one ZQ pin per die. The ZQ pin shall be connected to $V_{DD}Q$ through a 240 $\Omega$ ± 1% resistor.
V <sub>DD</sub> Q, V <sub>DD</sub> 1, V <sub>DD</sub> 2	Supply	Power Supplies: Isolated on the die for improved noise immunity.
V <sub>SS</sub> , V <sub>SS</sub> Q	GND	Ground Reference: Power supply ground reference
RESET_n	Input	<b>RESET:</b> When asserted LOW, the RESET_n signal resets both channels of the die.



#### **ORDERING INFORMATION – Valid Part Numbers**





# ORDERING INFORMATION, 256Mb x 32 LPDDR4

Industrial Range:  $T_c = -40^{\circ}C$  to  $+95^{\circ}C$ 

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS43LQ32256A-075BLI	200 ball FBGA, lead free
1600 MHz	-062	IS43LQ32256A-062BLI	200 ball FBGA, lead free

Automotive, A1 Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256A-075BLA1	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256A-062BLA1	200 ball FBGA, lead free

Automotive, A2 Range: Tc = -40°C to +105°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256A-075BLA2	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256A-062BLA2	200 ball FBGA, lead free

Automotive, A3 Range: Tc = -40°C to +125°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256A-075BLA3	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256A-062BLA3	200 ball FBGA, lead free



# ORDERING INFORMATION, 256Mb x 32 LPDDR4X

Industrial Range:  $T_c = -40^{\circ}C$  to  $+95^{\circ}C$ 

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS43LQ32256AL-075BLI	200 ball FBGA, lead free
1600 MHz	-062	IS43LQ32256AL-062BLI	200 ball FBGA, lead free

Automotive, A1 Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256AL-075BLA1	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256AL-062BLA1	200 ball FBGA, lead free

Automotive, A2 Range: Tc = -40°C to +105°C

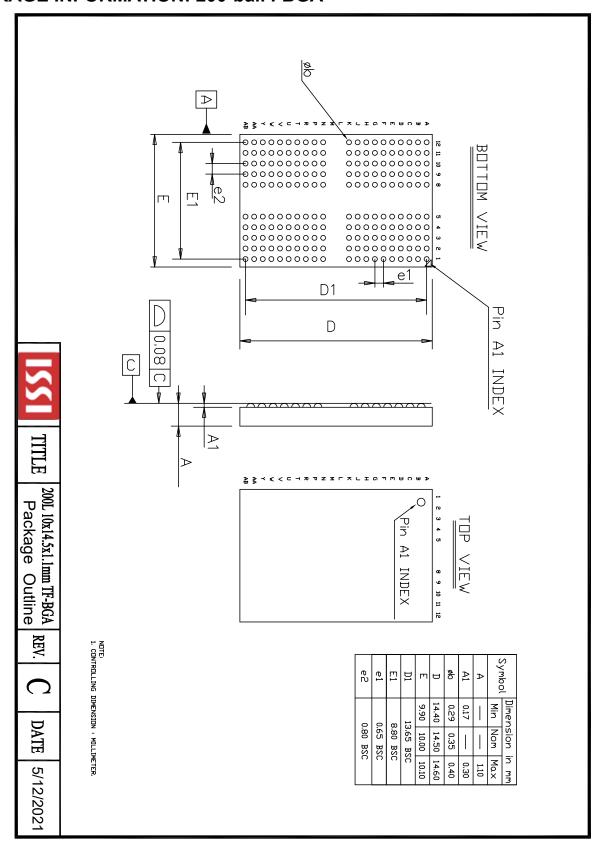
Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256AL-075BLA2	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256AL-062BLA2	200 ball FBGA, lead free

Automotive, A3 Range:  $T_c = -40^{\circ}C$  to  $+125^{\circ}C$ 

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256AL-075BLA3	200 ball FBGA, lead free
1600 MHz	-062	IS46LQ32256AL-062BLA3	200 ball FBGA, lead free



## **PACKAGE INFORMATION: 200-ball FBGA**



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for DRAM category:

Click to view products by ISSI manufacturer:

Other Similar products are found below:

CT51264BF160B M366S0924FTS-C7A00 AS4C16M32MD1-5BCN HM514100AZ-80 K4S560432C-TC75 K4S641632H-UC60

AS4C16M32MD1-5BIN AS4C64M8D1-5TCN ATCA-7360-MEM-4G MN41C4256A-07 IS43LR16800G-6BLI MT48LC8M16A2F4-6A

IT:L DEMT46H128M16LFCK6ITA W972GG6KB-25 TR W97AH2KBVX2I AS4C64M16D1A-6TCN AS4C256M8D2-25BIN

AS4C64M8D1-5BCN MT52L256M32D1PF-107 WT:B TR AS4C128M16MD2-25BCN AS4C8M16D1-5BCN AS4C64M32MD2-25BCN

AS4C128M16MD2A-25BIN AS4C128M32MD2-18BCN AS4C32M32MD2-25BCN IS43LR16800G-6BL W971GG6SB-18

AS4C64M16D3B-12BINTR MT44K16M36RB-125E:A TR MT44K16M36RB-107E:A TR AS4C128M8D2A-25BIN AS4C128M8D2A-25BCN AS4C32M16SB-7TINTR NT5AD256M16D4-HR AS4C256M16D3C-93BCN AS4C128M16D3LC-12BIN AS4C128M16D3LC-12BCN AS4C64M32MD1A-5BIN MT40A512M8SA-062E:F TR IS45S32800J-7TLA2 AS4C256M16D3LC-12BCN IS66WVH32M8DALL-166B1LI AS4C16M16SB-6TIN AS4C16M16SB-7TCN K4B2G1646F-BCNB AS4C2M32SA-6TINTR AS4C16M16SB-6BIN

MT48LC64M8A2P-75:C TR MT40A2G8JC-062E IT:E MT40A1G16KH-062E AIT:E